

# Chemical Sensing of 2D Graphene/MoS<sub>2</sub> Heterostructure device

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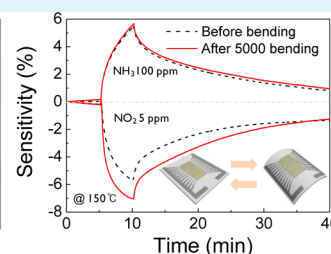
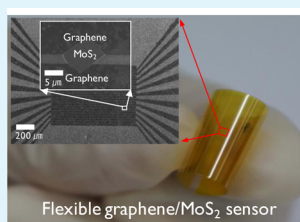
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## S Supporting Information

**ABSTRACT:** We report the production of a two-dimensional (2D) heterostructured gas sensor. The gas-sensing characteristics of exfoliated molybdenum disulfide (MoS<sub>2</sub>) connected to interdigitated metal electrodes were investigated. The MoS<sub>2</sub> flake-based sensor detected a NO<sub>2</sub> concentration as low as 1.2 ppm and exhibited excellent gas-sensing stability. Instead of metal electrodes, patterned graphene was used for charge collection in the MoS<sub>2</sub>-based sensing devices. An equation based on variable resistance terms was used to describe the sensing mechanism of the graphene/MoS<sub>2</sub> device. Furthermore, the gas response characteristics of the heterostructured device on a flexible substrate were retained without serious performance degradation, even under mechanical deformation. This novel sensing structure based on a 2D heterostructure promises to provide a simple route to an essential sensing platform for wearable electronics.

**KEYWORDS:** MoS<sub>2</sub>, graphene, gas sensor, heterostructure, flexible device



## INTRODUCTION

In recent years, atomically layered transition metal dichalcogenides (TMDs), which are distinct from van der Waals (vdW)-stacked bulk TMDs, have stimulated intensive research due to their intriguing physical properties and versatile electronic applications.<sup>1–9</sup> Molybdenum disulfide (MoS<sub>2</sub>) has been a major focus of these studies.<sup>10,11</sup> The use of single atomic layers of MoS<sub>2</sub> offers extremely large surface-to-volume ratios, low power consumption, high compatibility for integration with conventional Si technology, and inherent flexibility. The successful demonstration of quasi-two-dimensional (2D) MoS<sub>2</sub>-based field-effect transistors,<sup>11–15</sup> photodetectors,<sup>16,17</sup> and gas sensors<sup>18–21</sup> has motivated an exploration of the unusual physical properties of MoS<sub>2</sub> atomic layers.

The ultimate goal of the development of nanomaterial-based electronic devices is to produce atomically stacked 2D architectures via synergistic combinations of atomic-layered nanomaterials with dissimilar physical properties; such devices are often referred to as vdW heterostructure devices.<sup>22–26</sup> Strong covalent bonds in-plane and relatively weak vdW interactions out-of-plane provide the structural stability for these atomic-scale heterostructures.<sup>22</sup> Various types of such heterostructures have been investigated recently, enabling elucidation of the underlying physics.<sup>23,24</sup> A recent flurry of

activity in this research field involves the interesting characteristics of a diverse range of low-dimensional heterostructures, such as h-BN–graphene,<sup>27</sup> TMD–TMD,<sup>24,26</sup> and TMD–graphene.<sup>28</sup> However, these low-dimensional heterostructures mostly have been limited to field-effect transistor and photonic applications.<sup>3</sup> Gas-phase detection involving TMDs, especially MoS<sub>2</sub>, has exhibited an extraordinary sensing capability that is superior to that of carbon-based nanomaterials.<sup>19</sup> A structural advantage of MoS<sub>2</sub>, such as its high surface-to-volume ratio, can be translated into highly sensitive gas-sensor applications via charge transfer on the surface of MoS<sub>2</sub>.<sup>29,30</sup> Graphene can also be used to detect individual molecules, leading to the ultimate sensitivity.<sup>31</sup> Therefore, it is imperative to fabricate and investigate a novel 2D sensing platform utilizing 2D heterostructures. Furthermore, the flexible gas-sensing capability of such 2D heterostructures for wearable electronics should also be verified.

Here, we report the development of an atomically thin heterostructure-based gas sensor via a combination of mechanically exfoliated MoS<sub>2</sub> and graphene synthesized via

Received: May 25, 2015

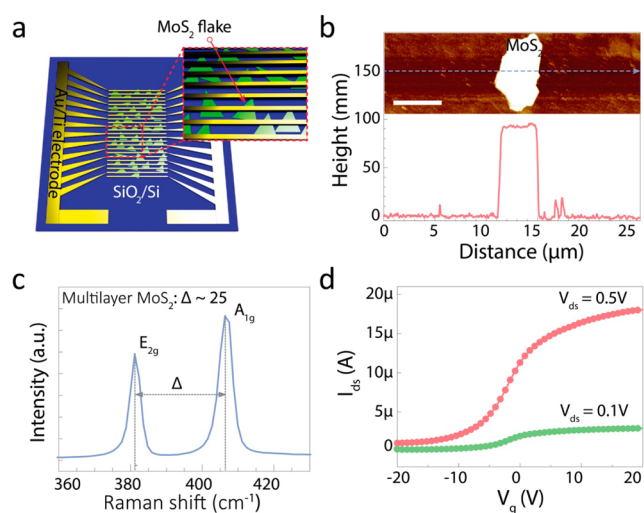
Accepted: July 10, 2015

Published: July 10, 2015

chemical vapor deposition (CVD). First, we explored the gas-sensing capability of the MoS<sub>2</sub>-based device. The exfoliated MoS<sub>2</sub> connected to interdigitated metal electrodes functions as an active nanomaterial for detecting gas molecules. The detection limit of the MoS<sub>2</sub> flake-based gas sensor was 1.2 ppm of NO<sub>2</sub>, and the sensor exhibited excellent gas-sensing stability. Second, a patterned graphene film, substituting for metal electrodes, was used for charge collection of the MoS<sub>2</sub>-based sensing devices. On the basis of an equation of the variable resistance terms, the sensing mechanism of the graphene/MoS<sub>2</sub> device was examined in detail. Furthermore, the gas-response characteristics of the flexible graphene/MoS<sub>2</sub> device were well maintained, without any serious performance degradation, even after a harsh bending test. The 2D heterostructure provides a simple route to an essential sensing component of wearable electronics.

## RESULTS AND DISCUSSION

Figure 1a shows an Au/Ti/MoS<sub>2</sub> device comprised of MoS<sub>2</sub> flakes exfoliated using the Scotch tape method and

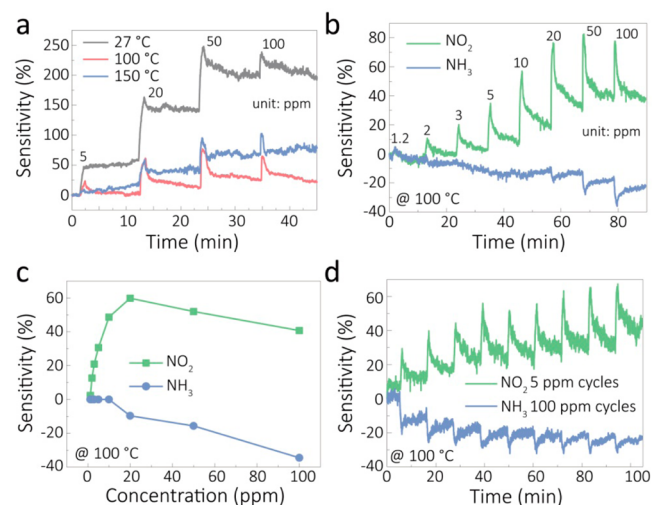


**Figure 1.** MoS<sub>2</sub> device with Au/Ti interdigitated electrodes. (a) Schematic image of MoS<sub>2</sub> flakes bridging Au/Ti interdigitated electrodes. (b) AFM height profile of a MoS<sub>2</sub> flake. The inset image shows an AFM morphology image of the MoS<sub>2</sub> flake connected to two electrode lines. The scale bar is 5 μm. (c) Raman spectrum of MoS<sub>2</sub>. Delta between E<sub>2g</sub> and A<sub>1g</sub> is 25 cm<sup>-1</sup>, which indicates multilayer MoS<sub>2</sub>. (d) V<sub>g</sub>-I<sub>d</sub> transfer characteristics of Au/Ti/MoS<sub>2</sub> FET device, showing *n*-type behavior.

interdigitated Au/Ti electrodes. The height of the flake bridging two electrodes was measured to be approximately 90 nm (Figure 1b). The details of the device fabrication can be found in Figure S1 (SI). The Raman spectrum represents the in-plane vibrational mode (E<sub>2g</sub>) and the out-of-plane vibrational mode (A<sub>1g</sub>) from the multilayer MoS<sub>2</sub> film, as shown in Figure 1c.<sup>32</sup> The peak-position difference (Δ) between E<sub>2g</sub> and A<sub>1g</sub> was approximately 25 cm<sup>-1</sup>, which is an indication that the exfoliated MoS<sub>2</sub> flakes are multilayered.<sup>33–35</sup> To determine the electrical properties of the multilayered MoS<sub>2</sub> flakes, we measured the MoS<sub>2</sub> field-effect transistor (FET) characteristics. The V<sub>g</sub>-I<sub>d</sub> transfer characteristics revealed the *n*-type character of the MoS<sub>2</sub> FET device, which is in good agreement with the results of previous studies (Figure 1d).<sup>11,36</sup> The V<sub>d</sub>-I<sub>d</sub>

characteristics modulated by V<sub>g</sub> are also shown in Figure S2 (SI).

The gas-sensing characteristics of the Au/Ti/MoS<sub>2</sub> device based on chemoresistance were explored. Transient resistance responses to NO<sub>2</sub> gas molecules with increasing concentration at various temperatures are shown in Figure 2a. The gas

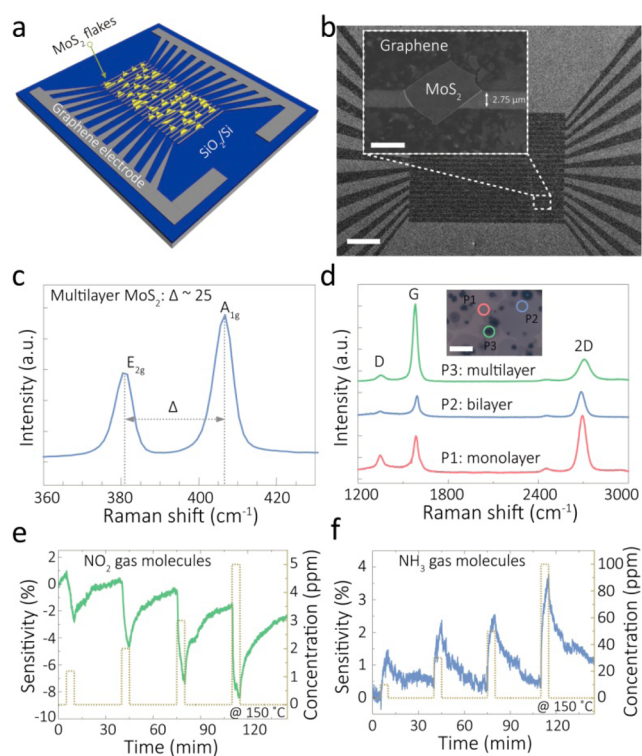


**Figure 2.** (a) Transient NO<sub>2</sub> gas-sensing characteristics of the Au/Ti/MoS<sub>2</sub> device. The sensitivity and recovery of the device strongly depend on the gas concentrations (5, 20, 50, and 100 ppm) and operating temperatures (27, 100, and 150 °C). (b) Transient responses to NO<sub>2</sub> and NH<sub>3</sub> with 1.2 to 100 ppm. (c) Sensitivity summary of the Au/Ti/MoS<sub>2</sub> device. NO<sub>2</sub> sensitivity is saturated at the relatively low concentration of 20 ppm, whereas NH<sub>3</sub> shows a continual increase in the sensitivity up to 100 ppm. (d) Cycling test for checking the reversible gas-sensing characteristics. The device was tested under two conditions: 5 ppm of NO<sub>2</sub> and 100 ppm of NH<sub>3</sub>. Overall, the sensing characteristics were optimized at an operating temperature of 100 °C.

sensitivity is defined as  $\Delta R/R_{N_2} = (R_g - R_{N_2})/R_{N_2}$ , where  $R_{N_2}$  and  $R_g$  represent the resistance under N<sub>2</sub> gas and the resistance to analyte gas, respectively. When the Au/Ti/MoS<sub>2</sub> sensing device was exposed to NO<sub>2</sub> gas, its resistance began to increase (positive sensitivity). This behavior indicates that the NO<sub>2</sub> molecules attract electrons from the *n*-type MoS<sub>2</sub>, leading to an increase in its resistance.<sup>30</sup> Thermal energy is well-known to accelerate the desorption process of gas molecules from a sensing film under inert gas flow.<sup>37,38</sup> With the aid of thermal activation, the recovery rate of the Au/Ti/MoS<sub>2</sub> sensing device was effectively increased. In particular, several sensing-performance parameters, including the sensitivity and recovery, appeared to be optimized at approximately 100 °C; therefore, we chose 100 °C as the operational temperature of the following gas-sensing tests (Figure 2a). As shown in Figure 2b, the transient resistance responses were compared using two analyte gases (NO<sub>2</sub> and NH<sub>3</sub> at concentrations ranging from 1.2 to 100 ppm). In contrast to the resistance change by NO<sub>2</sub> gas molecules, the resistance of the Au/Ti/MoS<sub>2</sub> sensing device decreased with the adsorption of NH<sub>3</sub> gas molecules (negative sensitivity). NH<sub>3</sub> acts as an electron donor, giving an electron to the *n*-type MoS<sub>2</sub>, thereby decreasing the resistance of the MoS<sub>2</sub>. Overall, the NH<sub>3</sub> sensitivities were observed to be lower than those of NO<sub>2</sub> due to the relatively smaller charge transfer of NH<sub>3</sub>.<sup>29,39</sup> Furthermore, the band structures for both valence bands and conduction bands of MoS<sub>2</sub> are not significantly

altered when  $\text{NH}_3$  is adsorbed; however,  $\text{NO}_2$ -adsorbed  $\text{MoS}_2$  induces an unoccupied state above Fermi level.<sup>39</sup> These theoretical results support the reason  $\text{NO}_2$  on our  $\text{MoS}_2$  gas sensor is much more sensitive than  $\text{NH}_3$ . Figure 2c is a summary of the strong reliance of the sensitivity on the gas concentration. The surface chemical reaction between the  $\text{MoS}_2$  channel and the  $\text{NO}_2$  molecules continually increased up to 20 ppm; however, the reaction plateaued for further increases in concentration. In contrast, the sensitivity to  $\text{NH}_3$  continually increased to 100 ppm, although the sensitivities below 20 ppm are negligible. This is due to the difference in the adsorption energy and the amount of transferred charge of each molecule to the 2D sensing film.<sup>39</sup> A cycling test via alternating injections of  $\text{N}_2$  and the analyte gas is an important requirement for practical sensor applications. In spite of a baseline shift, the gas-sensing characteristics of our Au/Ti/ $\text{MoS}_2$  devices were highly stable over many cycling tests upon exposure to 5 ppm of  $\text{NO}_2$  and 100 ppm of  $\text{NH}_3$  (Figure 2d).

To create flexible sensors, we used a graphene electrode for the devices. Figure 3a shows a schematic drawing of the graphene/ $\text{MoS}_2$  device for the gas-sensing test. Exfoliated  $\text{MoS}_2$  flakes and patterned graphene lines are used for the channel and the electrodes, respectively (Figure 3b). The morphology



**Figure 3.** (a) Schematic image of the  $\text{MoS}_2$  device with patterned graphene electrodes. (b) SEM image of the  $\text{MoS}_2$  device with interdigitated graphene electrodes. The scale bar is  $200\ \mu\text{m}$ . The inset image shows the  $\text{MoS}_2$  flake bridging two graphene lines. The inset scale bar is  $5\ \mu\text{m}$ . (c) Raman spectrum of a  $\text{MoS}_2$  flake, indicating its multilayer characteristics. Delta between  $E_{2g}$  and  $A_{1g}$  is  $25\ \text{cm}^{-1}$ . (d) Raman spectra of mono-, bi-, and multilayer graphene. The inset shows an optical microscopy image of the graphene marked with P1 (monolayer), P2 (bilayer) and P3 (multilayer) points. The inset scale bar is  $20\ \mu\text{m}$ . (e) Transient response to  $\text{NO}_2$  gas molecules (1.2 to 5 ppm). (f) Transient response to  $\text{NH}_3$  gas molecules (5 to 100 ppm). All gas-sensing tests were performed at an operating temperature of  $150\ ^\circ\text{C}$ .

and thickness of the 2D heterostructure were also analyzed using atomic force microscopy (AFM; Figure S6, SI). To identify the existence of  $\text{MoS}_2$  and graphene, Raman spectroscopy was performed. Figure 3c indicates that the exfoliated  $\text{MoS}_2$  is multilayered because its peak position difference ( $\Delta$ ) between  $E_{2g}$  and  $A_{1g}$  was nearly  $25\ \text{cm}^{-1}$ .<sup>33–35</sup> Figure 3d displays the Raman spectra recorded from various points (P1, P2, and P3 in the inset of Figure 3d) on the graphene film, which can be clearly distinguished in the optical image by contrast differences. The Raman spectrum recorded from CVD-synthesized graphene film has three characteristic bands: D, G, and 2D. The D band is activated in the first-order scattering by in-plane substitutional heteroatoms, vacancies, or other defects.<sup>40</sup> The G and 2D bands are related to the in-plane vibrations of  $\text{sp}^2$  carbon atoms in single-layer graphene and the stacking order along the  $c$  axis of graphene.<sup>41</sup> Therefore, the graphene thickness can be precisely estimated from the intensity ratio of the 2D band to the G band,  $I_{2D}/I_G$ , as follows:  $I_{2D}/I_G = 2$  for a monolayer,  $I_{2D}/I_G = 1$  for a bilayer, and  $I_{2D}/I_G < 1$  for a multilayer structure.<sup>42</sup> Figure 3e displays the sensitivity of the graphene/ $\text{MoS}_2$  sensing device under  $\text{NO}_2$  gas concentrations of 1.2, 2, 3, and 5 ppm. The gas-sensing performance of the graphene/ $\text{MoS}_2$  sensing device, including recovery and sensitivity, was optimized over the operating temperature range of 150 to  $200\ ^\circ\text{C}$  (Figure S3, SI). Thus, the following tests were performed at  $150\ ^\circ\text{C}$ . The difference of the optimized annealing temperature range between two different devices ( $100\ ^\circ\text{C}$  for  $\text{MoS}_2$  only vs  $150\ ^\circ\text{C}$  for graphene/ $\text{MoS}_2$ ) might come from the introduction of graphene. Molecules can be adsorbed strongly to graphene.<sup>43</sup> Furthermore, the defective and edge sites on our CVD-synthesized graphene inhibit the desorption process of gas molecules, which indicates that higher thermal energy is required compared with the  $\text{MoS}_2$  only sensing device. The contribution of the graphene to a gas-sensing property will be discussed later. The injection of  $\text{NO}_2$  gas molecules induced negative sensitivity (i.e., the resistance decreased). When the  $\text{NO}_2$  gas was turned on, the device resistance tended to recover to the initial resistance value. In contrast,  $\text{NH}_3$  gas molecules caused an increase in the device resistance, as shown in Figure 3f. As the  $\text{NH}_3$  concentration increased from 5 to 100 ppm, the sensitivity moderately increased. The detection limit for  $\text{NO}_2$  was much lower than that of  $\text{NH}_3$ . This difference is due to the higher adsorption energy of  $\text{NO}_2$  molecules compared to that of  $\text{NH}_3$  molecules.<sup>44,45</sup> The gas-sensing characteristics of the graphene/ $\text{MoS}_2$  devices were reproducible even though there was some device-to-device variation in base resistance and gas sensitivity (Figure S4, SI).

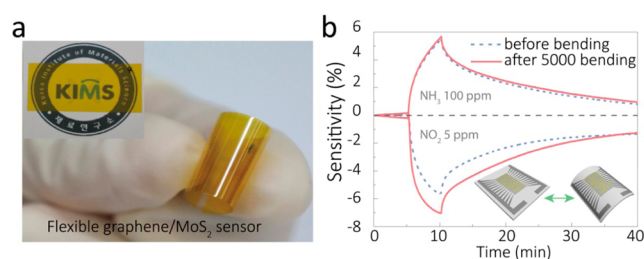
Note that, unlike the  $n$ -type behavior of Au/Ti/ $\text{MoS}_2$ , the graphene/ $\text{MoS}_2$  heterojunction gas sensor operated as a  $p$ -type device. It is hard to explain the exact origin of majority carrier transition mechanism for each different device (Au/Ti/ $\text{MoS}_2$  vs graphene/ $\text{MoS}_2$ ). Nevertheless, we can consider a possible reason: compared to the Ti metal (low work function of 4.3 eV), relatively high work function of graphene (4.7 eV) facilitate hole transport toward valence band edge of  $\text{MoS}_2$ , which might be responsible for  $p$ -type gas-sensing characteristics. On one hand, the sensitivity difference in two devices primarily results from largely different carrier concentration. Apparently, carrier concentration flowing throughout the graphene/ $\text{MoS}_2$  device is much higher than that of Au/Ti/ $\text{MoS}_2$ , which might cause the large difference in gas-sensing characteristics (Table S1, SI). Chemoresistive gas-sensing

devices rely on a resistance change upon gas injection. The total resistance of the device can be expressed as follows:

$$R_{\text{total}} = R_{\text{channel}} + R_{\text{contact}} + R_{\text{electrode}} \quad (1)$$

We can assume that  $R_{\text{channel}}$  corresponded to the resistance of  $\text{MoS}_2$ . The two remaining terms ( $R_{\text{contact}}$  and  $R_{\text{electrode}}$ ) then dominate the difference in the gas-sensing behavior. The former ( $R_{\text{contact}}$ ) is strongly related to the electronic barrier height (occasionally known as the Schottky barrier height) formed on the active material/electrode interface. The graphene junction to the  $\text{MoS}_2$  film usually causes the barrier height to be even lower,<sup>46</sup> which results in less modulation upon gas adsorption than for a metal- $\text{MoS}_2$  junction. The latter ( $R_{\text{electrode}}$ ) is usually negligible for metal contacts. However, the resistivity value of a graphene electrode is 2–3 orders of magnitude higher than that of a metal;<sup>47</sup> therefore, the  $R_{\text{electrode}}$  value cannot be completely excluded in  $R_{\text{total}}$ . Graphene itself has been reported to sensitively respond to gas molecules. It is concluded that the  $R_{\text{electrode}}$  value can be changed by gas adsorption, which therefore contributes to the change in  $R_{\text{total}}$ .

To investigate the potential capacity of a flexible sensor, we fabricated a graphene/ $\text{MoS}_2$  gas-sensing device on a polyimide substrate. Figure 4a is an optical image of a bent graphene/



**Figure 4.** (a) Optical image of a graphene/ $\text{MoS}_2$  heterostructured device on a bent polyimide substrate and (inset) the semitransparent sensing device placed on a paper with the KIMS logo. (b) Comparison of the gas response characteristics of the flexible heterostructured device before/after the bending cycle test; (inset) 3D schematic images showing the bending test condition. No serious performance degradation was observed, even after performing 5000 bending cycle tests. The gas-sensing tests were performed at 150 °C. According to the material specification of the PI substrate film used, the temperature range from  $-269$  to 400 °C is acceptable for its applications, which indicates that our annealing condition does not degrade the PI flexible film seriously.

$\text{MoS}_2$  gas-sensing device fabricated on a polyimide substrate. The fabrication details are shown in the [Experimental Methods](#) section. The inset in [Figure 4a](#) shows a semitransparent sensing device before mechanical deformation. As shown in [Figure S7 \(SI\)](#), the device resistance remained stable during a bending test (monitoring the resistance change as a function of the bending cycles or bending radius). The gas response characteristic of the flexible graphene/ $\text{MoS}_2$  device at 150 °C was well maintained, without any significant degradation even after 5000 bending cycles. Because the polyimide is highly resistant to thermal stress, this elevated testing temperature could be applied to the flexible device. Furthermore, the flexible graphene/ $\text{MoS}_2$  gas sensor device still worked well even after 19 months, showing extraordinary long-term stability ([Figure S8, SI](#)). Thus, highly sensitive and reliable performance was demonstrated for these flexible, 2D-heterostructured gas-sensing devices, enabling a promising sensing platform for futuristic wearable electronics.

## CONCLUSION

We have demonstrated atomically thin, heterostructured gas sensors comprising a combination of exfoliated  $\text{MoS}_2$  and CVD graphene. First, we showed that a  $\text{MoS}_2$  device with Au/Ti metal electrodes could sensitively detect  $\text{NO}_2$  gas molecules above a concentration of 1.2 ppm with excellent gas-sensing stability. Second, we used patterned graphene film instead of a metal for charge collection in a 2D  $\text{MoS}_2$ -based sensing device. Based on an equation containing several resistance terms, the sensing mechanism of the graphene/ $\text{MoS}_2$  device was carefully described. Furthermore, the gas response characteristic of the 2D heterostructure fabricated on a flexible substrate did not exhibit serious degradation, even after 5000 bending cycle tests. This novel 2D heterostructured architecture represents an advance in the development of an important sensing component of futuristic wearable electronics.

## EXPERIMENTAL METHODS

**CVD Synthesis of Graphene.** A Ni/Ti film (300/30 nm) was deposited onto a  $\text{SiO}_2$  (300 nm)/Si wafer using an e-beam evaporator. The wafer was placed at the center of a quartz tube and then annealed at 300 °C under a pressure of 800 Torr for 30 min with Ar (2000 sccm)/ $\text{H}_2$  (80 sccm) to remove the oxide layer formed on the Ni film. When the temperature reached 900 °C, the graphene film was synthesized onto the Ni film under Ar (2000 sccm)/ $\text{H}_2$  (80 sccm)/ $\text{CH}_4$  (20 sccm) for 5 min, and then the quartz tube was cooled.

**Fabrication of Au/Ti/ $\text{MoS}_2$  Gas-Sensing Devices.** [Figure S1 \(SI\)](#) shows schematic diagrams of the fabrication process on a hard substrate. First, a Si substrate with a thermally grown  $\text{SiO}_2$  (100 nm) layer was cleaned using sonication in acetone, isopropyl alcohol (IPA), and DI water for 5 min each. Next, multilayer  $\text{MoS}_2$  flakes were transferred to the substrate via mechanical exfoliation. Using conventional photolithography, interdigitated electrode regions with 3  $\mu\text{m}$  channel lengths were patterned. Finally, the metal electrode (Au/Ti = 50/50 nm) was deposited using an e-beam evaporator and then lifted off by acetone.

**Fabrication of Graphene/ $\text{MoS}_2$  Gas-Sensing Devices.** [Figure S5 \(SI\)](#) illustrates the sequential fabrication process of graphene/ $\text{MoS}_2$  device. First of all, a Si substrate with a  $\text{SiO}_2$  (100 nm) layer was prepared and cleaned. Next, multilayer  $\text{MoS}_2$  flakes were mechanically exfoliated onto the substrate. A multilayer graphene film was synthesized on a Si substrate with a Ni film (300 nm) using CVD and was subsequently patterned using conventional photolithography and reactive ion etching (RIE;  $\text{O}_2$ , 20 sccm; pressure, 200 mTorr; and power, 50 W). The graphene film was then transferred on  $\text{MoS}_2$  flakes. After spin-coating a poly(methyl methacrylate) (PMMA, MicroChem, 495k, A2) supporting layer onto the substrate, the device was transferred onto a polyimide substrate by etching the  $\text{SiO}_2$  sacrificial layer using buffered oxide etchant. Finally, the PMMA layer was removed by acetone.

## ASSOCIATED CONTENT

### Supporting Information

Fabrication process of Au/Ti/ $\text{MoS}_2$  device,  $V_d$ – $I_d$  output characteristics of Au/Ti/ $\text{MoS}_2$  FET device, operating temperature dependence of transient gas response characteristics in a graphene/ $\text{MoS}_2$  gas-sensing device, device-to-device variation of transient resistance response characteristics, comparison of sensing properties on each different device structure (Au/Ti/ $\text{MoS}_2$  vs graphene/ $\text{MoS}_2$ ), fabrication process of a graphene/ $\text{MoS}_2$  gas-sensing device, AFM measurement of graphene/ $\text{MoS}_2$  contact, bending performance of a graphene/ $\text{MoS}_2$  device, and long-term stability of a flexible graphene/ $\text{MoS}_2$  device. The Supporting Information is available free of charge

on the ACS Publications website at DOI: 10.1021/acsami.5b04541.

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### Author Contributions

<sup>†</sup>These authors contributed equally to this work. B.C., M.G.H., and H.C.K. designed and supervised the experiments. B.C., J.Y., S.K.L., and A.R.K. did the experiments. B.C., J.Y., D.-H.K., S.-G.P., J.-D.K., Y.-J.L., K.-H.L., and B.H.L. analyzed the data. B.C., J.Y., H.C.K., M.G.H., and D.-H.K. co-wrote the paper.

### Notes

The authors declare no competing financial interest.

## ACKNOWLEDGMENTS

This study was financially supported by the Fundamental Research Program (PNK4210) of the Korean Institute of Materials Science (KIMS). M.G.H. and B.C. are grateful for support from the Basic Science Research Program of the National Research Foundation of Korea (NRF) funded by the Ministry of Science, ICT & Future Planning (NRF-2014R1A1A1006214 and NRF-2014R1A1A1036139).

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